FAIRCHILD

SEMICONDUCTOR®

FDT86113LZ

N-Channel PowerTrench[®] MOSFET 100 V, 3.3 A, 100 m Ω

Features

- Max $r_{DS(on)}$ = 100 m Ω at V_{GS} = 10 V, I_D = 3.3 A
- Max $r_{DS(on)}$ = 145 m Ω at V_{GS} = 4.5 V, I_D = 2.7 A
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability in a widely used surface mount package
- HBM ESD protection level > 3 KV typical (Note 4)
- 100% UIL tested
- RoHS Compliant

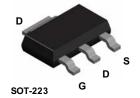


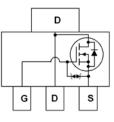
General Description

This N-Channel logic Level MOSFETs are produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been special tailored to minimize the on-state resistance and yet maintain superior switching performance. G-S zener has been added to enhance ESD voltage level.

Application

DC - DC Switch





MOSFET Maximum Ratings T_C = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage		±20	V		
-	Drain Current -Continuous			3.3		
I _D	-Pulsed			12	Α	
E _{AS}	Single Pulse Avalanche Energy (Note 3)		9	mJ		
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.2	- w	
PD	Power Dissipation	T _A = 25 °C	(Note 1b)	1.0		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	12	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note	a) 55	C/VV

Package Marking and Ordering Information

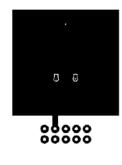
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
86113LZ	FDT86113LZ	SOT-223	13 "	12 mm	2500 units

March 2011

FDT86113LZ N
13LZ N-Ch
N-Channel PowerTrenc
verTrench [®]
[®] MOSFET
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Char	acteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	100			V	
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, referenced to 25 °C		71		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μA	
On Chara	acteristics (Note 2)						
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	1.0	1.7	2.5	V	
$\Delta V_{GS(th)}$ ΔT_J	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 µA, referenced to 25 °C		-5		mV/°C	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 3.3 A		75	100		
		V _{GS} = 4.5 V, I _D = 2.7 A		95	145	mΩ	
		V _{GS} = 10 V, I _D = 3.3 A, T _J = 125 °C		140	189	- 11122	
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 3.3 A		8		S	
-	Characteristics					T	
C _{iss}	Input Capacitance			234	315	pF	
C _{oss}	Output Capacitance	= f = 1 MHz		46	65	pF	
C _{rss}	Reverse Transfer Capacitance			3.1	5	pF	
Switchin	g Characteristics						
t _{d(on)}	Turn-On Delay Time			3.8	10	ns	
t _r	Rise Time	V _{DD} = 50 V, I _D = 3.3 A,		1.3	10	ns	
t _{d(off)}	Turn-Off Delay Time	V _{GS} = 10 V, R _{GEN} = 6 Ω		10	20	ns	
t _f	Fall Time			1.5	10	ns	
Q _q	Total Gate Charge	V _{GS} = 0 V to 10 V		4.1	6.8	nC	
0	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V V_{DD} = 50 V,$		2.3	3.9	nC	
ua ⊂	Gate to Source Gate Charge	I _D = 3.3 A		0.68		nC	
0	Cate to Course Cate Charge			0.85		nC	
Q _{gs}	Gate to Drain "Miller" Charge			0.00			
Q _{gs} Q _{gd}	-			0.00			
Q _{gs} Q _{gd} Drain-So	Gate to Drain "Miller" Charge	V _{GS} = 0 V, I _S = 3.3 A (Note 2)		0.86	1.3		
Q _g Q _{gs} Q _{gd} Drain-So V _{SD}	Gate to Drain "Miller" Charge	00 0			1.3	V	
Q _{gs} Q _{gd} Drain-So	Gate to Drain "Miller" Charge			0.86	-	- V ns	

Notes: 1. R_{6JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{6JC} is guaranteed by design while R_{6JA} is determined by the user's board design.



a) 55 °C/W when mounted on a 1 in² pad of 2 oz copper



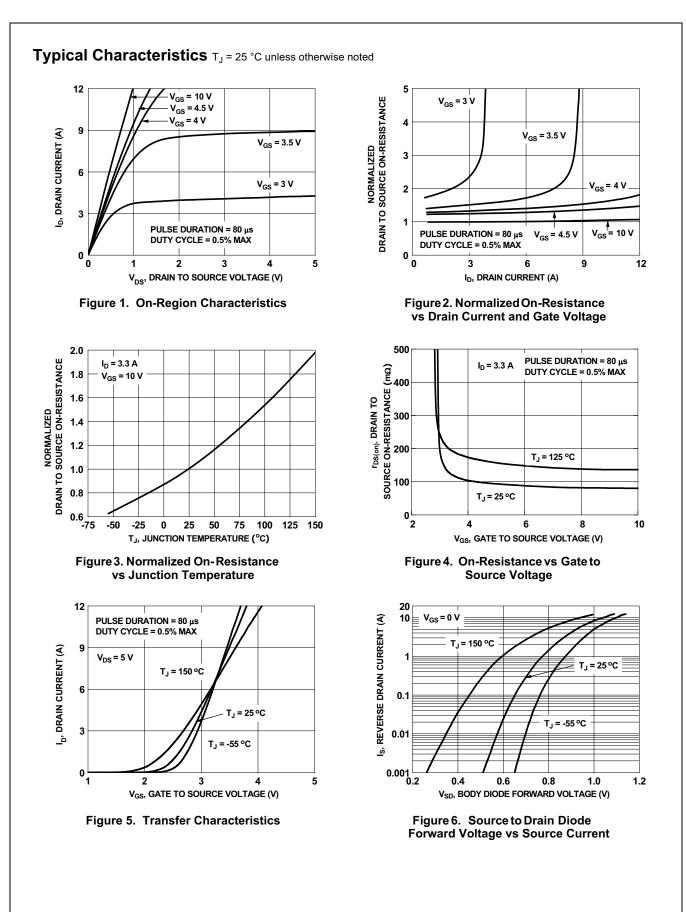
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b) 118 °C/W when mounted on a minimum pad of 2 oz copper

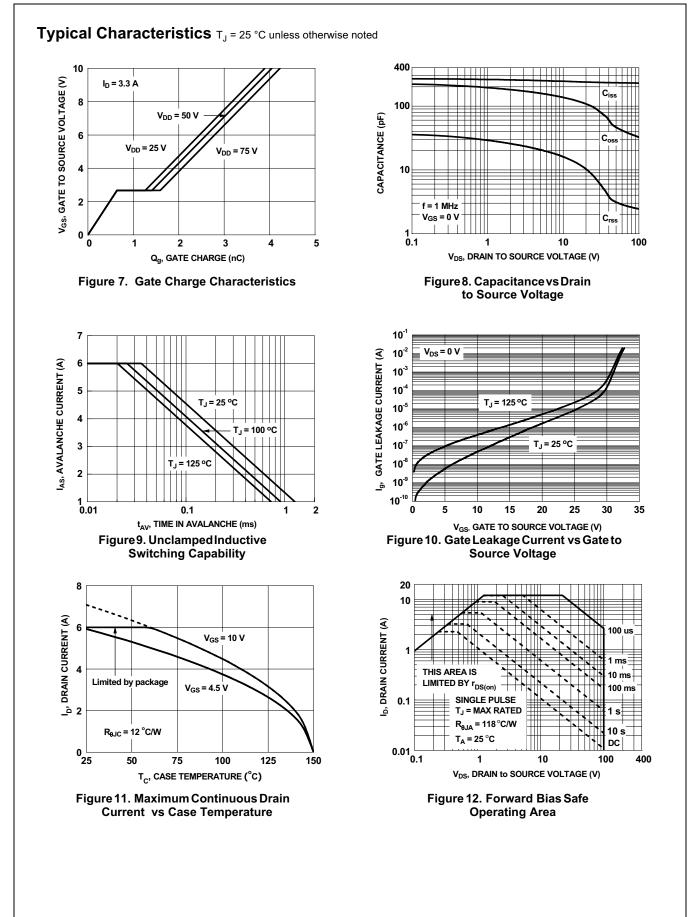
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

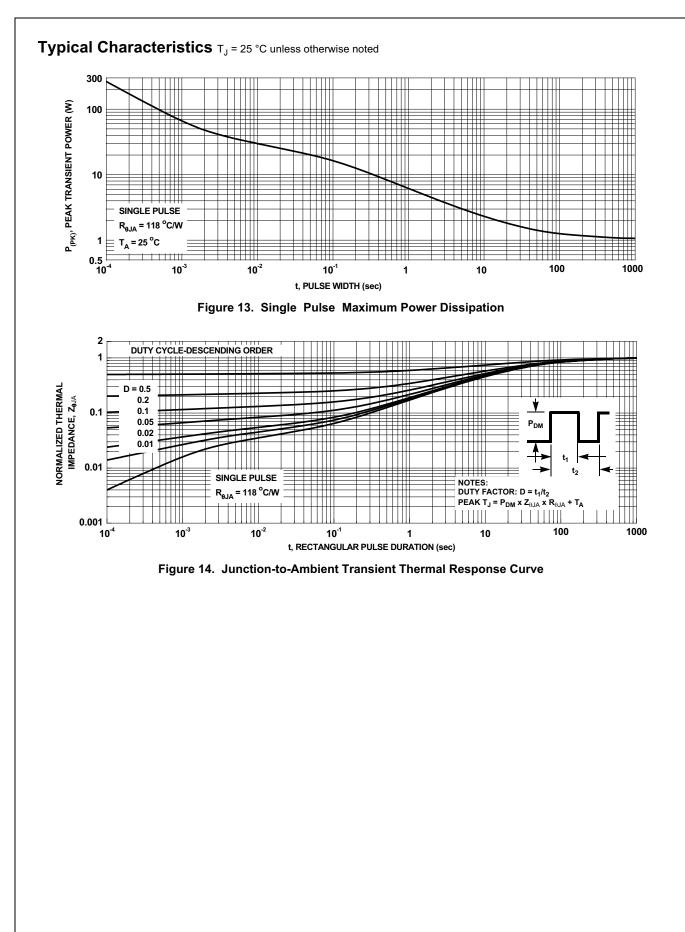
3. Starting $T_J = 25^{\circ}C$, L = 0.3 mH, $I_{AS} = 8$ A, $V_{DD} = 90$ V, $V_{GS} = 10$ V.

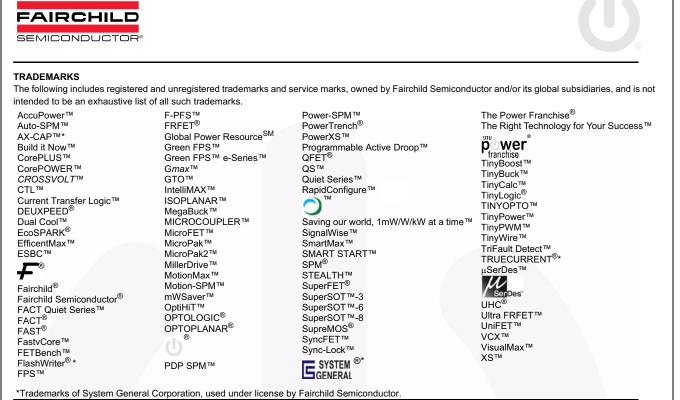
4. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.











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